

ABSTRACT OF THE DISCLOSURE

A method for collecting semiconductor devices and a method for selling and using semiconductor devices in consideration of collection are provided. When a user of an electrical appliance containing a semiconductor chip discards the electrical
5 appliance, the user disassembles the electrical appliance and removes the semiconductor chip from the printed board on which it is mounted (S1). The user can thus obtain a service number provided on the back (S2) and in step S3 reports the service number to the manufacturer of the electrical appliance, or the manufacturer of the semiconductor chip, or a service organization acting for the purpose of collection. When receiving the report,
10 the manufacturer or the service organization gives a reward to the user (S4) and separately collects the semiconductor chip (S5).